

Metallized Polyethylene-Naphthalate (PEN) SMD Film Capacitors with Box Encapsulation. Capacitances from 0.01 μF to 1.0 μF . Rated Voltages from 63 VDC to 400 VDC. Size Codes from 1812 to 2824.

Special Features

- Size codes 1812, 2220 and 2824, with PEN and encapsulated
- Operating temperature up to 125° C
- Self-healing
- Suitable for lead-free soldering
- According to RoHS 2011/65/EU

Typical Applications

For general DC-applications e.g.

- By-pass
- Blocking
- Coupling and decoupling
- Timing

Construction

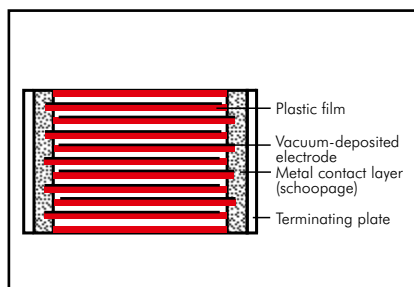
Dielectric:

Polyethylene-Naphthalate (PEN) film

Capacitor electrodes:

Vacuum-deposited

Internal construction:



Encapsulation:

Solvent-resistant, flame-retardant plastic case, UL 94 V-0

Terminations:

Tinned plates.

Marking:

Colour: Black.

Electrical Data

Capacitance range:

0.01 μF to 1.0 μF

Rated voltages:

63 VDC, 100 VDC, 250 VDC, 400 VDC

Capacitance tolerances:

$\pm 20\%$, $\pm 10\%$ ($\pm 5\%$ available subject to special enquiry)

Operating temperature range:

-55° C to +125° C

Climatic test category:

55/125/21 according to IEC

Insulation resistance at +20° C:

U_r	U_{test}	$C \leq 0.33 \mu\text{F}$	$0.33 \mu\text{F} < C \leq 1.0 \mu\text{F}$
63 VDC 100 VDC	50 V 100 V	$\geq 3.75 \times 10^3 \text{ M}\Omega$	$\geq 1250 \text{ sec (M}\Omega \times \mu\text{F)}$
$\geq 250 \text{ VDC}$	100 V	$\geq 1 \times 10^4 \text{ M}\Omega$	$\geq 3000 \text{ sec (M}\Omega \times \mu\text{F)}$

Measuring time: 1 min.

Dissipation factors at +20° C: $\tan \delta$

at f	$C \leq 0.1 \mu\text{F}$	$0.1 \mu\text{F} < C \leq 1.0 \mu\text{F}$
1 kHz	$\leq 8 \times 10^{-3}$	$\leq 8 \times 10^{-3}$
10 kHz	$\leq 15 \times 10^{-3}$	$\leq 15 \times 10^{-3}$
100 kHz	$\leq 30 \times 10^{-3}$	–

Maximum pulse rise time:

Capacitance μF	max. pulse rise time V/ μsec			
	63 VDC	100 VDC	250 VDC	400 VDC
0.01 ... 0.022	30	35	40	35
0.033 ... 0.068	20	20	40	21
0.1 ... 0.22	10	10	12	–
0.33 ... 0.68	8	6	–	–
1.0	3.5	4	–	–

Dip Solder Test/Processing

Resistance to soldering heat:

Test Tb in accordance with DIN IEC

60068-2-58/DIN EN 60384-23.

Soldering bath temperature max. 260° C.

Soldering duration max. 5 sec.

Change in capacitance $\Delta C/C < 5\%$.

Soldering process:

Re-flow soldering (see temperature/time graphs page 13).

Packing

Available taped and reeled in blister pack.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

Continuation

General Data

Capacitance	63 VDC/40 VAC*			100 VDC/63 VAC*		
	Size code	H ± 0.3	Part number	Size code	H ± 0.3	Part number
0.01 μ F	1812	3.0	SMDNC02100KA00_____	1812	3.0	SMDND02100KA00_____
	2220	3.5	SMDNC02100QA00_____	2220	3.5	SMDND02100QA00_____
	2824	3.0	SMDNC02100TA00_____	2824	3.0	SMDND02100TA00_____
0.015 "	1812	3.0	SMDNC02150KA00_____	1812	3.0	SMDND02150KA00_____
	2220	3.5	SMDNC02150QA00_____	2220	3.5	SMDND02150QA00_____
	2824	3.0	SMDNC02150TA00_____	2824	3.0	SMDND02150TA00_____
0.022 "	1812	3.0	SMDNC02220KA00_____	1812	3.0	SMDND02220KA00_____
	2220	3.5	SMDNC02220QA00_____	2220	3.5	SMDND02220QA00_____
	2824	3.0	SMDNC02220TA00_____	2824	3.0	SMDND02220TA00_____
0.033 "	1812	3.0	SMDNC02330KA00_____	1812	3.0	SMDND02330KA00_____
	2220	3.5	SMDNC02330QA00_____	2220	3.5	SMDND02330QA00_____
	2824	3.0	SMDNC02330TA00_____	2824	3.0	SMDND02330TA00_____
0.047 "	1812	3.0	SMDNC02470KA00_____	1812	3.0	SMDND02470KA00_____
	2220	3.5	SMDNC02470QA00_____	2220	3.5	SMDND02470QA00_____
	2824	3.0	SMDNC02470TA00_____	2824	3.0	SMDND02470TA00_____
0.068 "	1812	3.0	SMDNC02680KA00_____	1812	3.0	SMDND02680KA00_____
	2220	3.5	SMDNC02680QA00_____	2220	3.5	SMDND02680QA00_____
	2824	3.0	SMDNC02680TA00_____	2824	3.0	SMDND02680TA00_____
0.1 μ F	1812	4.0	SMDNC03100KB00_____	1812	4.0	SMDND03100KB00_____
	2220	3.5	SMDNC03100QA00_____	2220	3.5	SMDND03100QA00_____
	2824	3.0	SMDNC03100TA00_____	2824	3.0	SMDND03100TA00_____
0.15 "	1812	4.0	SMDNC03150KB00_____	1812	4.0	SMDND03150KB00_____
	2220	3.5	SMDNC03150QA00_____	2220	3.5	SMDND03150QA00_____
	2824	3.0	SMDNC03150TA00_____	2824	3.0	SMDND03150TA00_____
0.22 "	2220	3.5	SMDNC03220QA00_____	2220	3.5	SMDND03220QA00_____
	2824	3.0	SMDNC03220TA00_____	2824	3.0	SMDND03220TA00_____
0.33 "	2220	4.5	SMDNC03330QB00_____	2220	4.5	SMDND03330QB00_____
	2824	5.0	SMDNC03330TB00_____	2824	5.0	SMDND03330TB00_____
0.47 "	2220	4.5	SMDNC03470QB00_____	2220	4.5	SMDND03470QB00_____
	2824	5.0	SMDNC03470TB00_____	2824	5.0	SMDND03470TB00_____
0.68 "	2824	5.0	SMDNC03680TB00_____	2824	5.0	SMDND03680TB00_____
1.0 μ F	2824	5.0	SMDNC04100TB00_____	2824	5.0	SMDND04100TB00_____

* AC voltage: $f = 50 \text{ Hz}$; $1.4 \times U_{\text{rms}} + U_{\text{DC}} \leq U_r$

Dims in mm.

Part number completion:

Tolerance: 20 % = M
10 % = K
5 % = J

Packing: bulk = S

Pin length: none = 00

Taped version see page 160.

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Continuation page 22

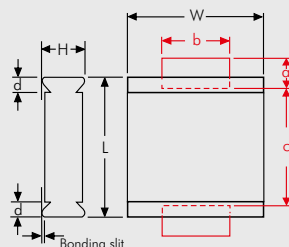
Continuation

General Data

Capacitance	250 VDC/160 VAC*			400 VDC/200 VAC*		
	Size code	H ± 0.3	Part number	Size code	H ± 0.3	Part number
0.01 μF	2220 2824	3.5 3.0	SMDNF02100QA00_____ SMDNF02100TA00_____ SMDNF02100TA00_____ SMDNF02100TA00_____	2824	3.0	SMDNG02100TA00_____ SMDNG02100TA00_____ SMDNG02100TA00_____ SMDNG02100TA00_____
0.015 „	2220 2824	3.5 3.0	SMDNF02150QA00_____ SMDNF02150TA00_____ SMDNF02150TA00_____ SMDNF02150TA00_____	2824	3.0	SMDNG02150TA00_____ SMDNG02150TA00_____ SMDNG02150TA00_____ SMDNG02150TA00_____
0.022 „	2220 2824	3.5 3.0	SMDNF02220QA00_____ SMDNF02220TA00_____ SMDNF02220TA00_____ SMDNF02220TA00_____	2824	5.0	SMDNG02220TB00_____ SMDNG02220TB00_____ SMDNG02220TB00_____ SMDNG02220TB00_____
0.033 „	2220 2824	3.5 3.0	SMDNF02330QA00_____ SMDNF02330TA00_____ SMDNF02330TA00_____ SMDNF02330TA00_____	2824	5.0	SMDNG02330TB00_____ SMDNG02330TB00_____ SMDNG02330TB00_____ SMDNG02330TB00_____
0.047 „	2220 2824	3.5 3.0	SMDNF02470QA00_____ SMDNF02470TA00_____ SMDNF02470TA00_____ SMDNF02470TA00_____	2824	5.0	SMDNG02470TB00_____ SMDNG02470TB00_____ SMDNG02470TB00_____ SMDNG02470TB00_____
0.068 „	2220 2824	4.5 3.0	SMDNF02680QB00_____ SMDNF02680TA00_____ SMDNF02680TA00_____ SMDNF02680TA00_____			
0.1 μF	2220 2824	4.5 5.0	SMDNF03100QB00_____ SMDNF03100TB00_____ SMDNF03100TB00_____ SMDNF03100TB00_____			
0.15 „	2824	5.0	SMDNF03150TB00_____ SMDNF03150TB00_____ SMDNF03150TB00_____ SMDNF03150TB00_____			

* AC voltage: $f = 50 \text{ Hz}$; $1.4 \times U_{\text{rms}} + \text{UDC} \leq U_r$

Dims in mm.



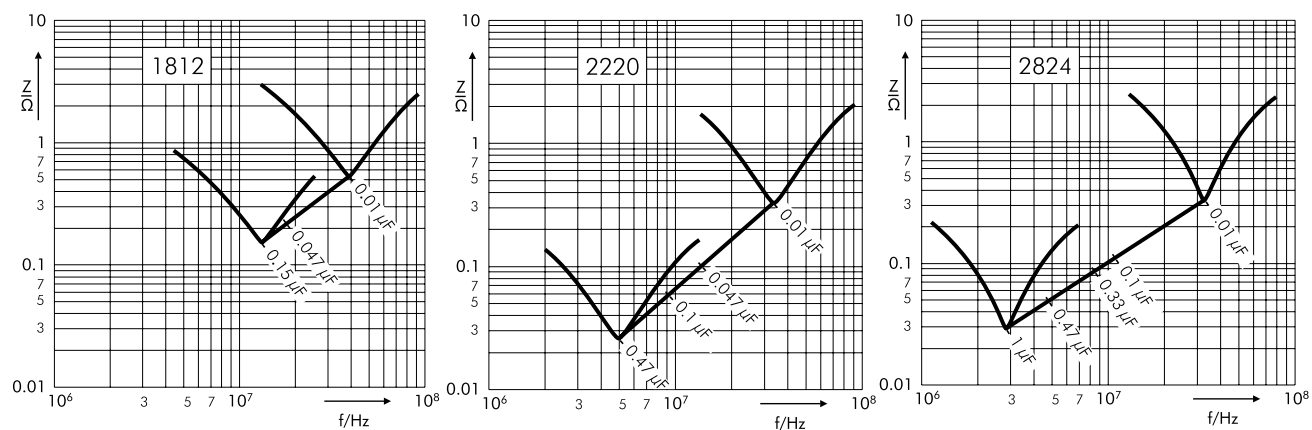
Part number completion:	
Tolerance:	20 % = M 10 % = K 5 % = J
Packing:	bulk = S
Pin length:	none = 00
Taped version see page 160.	

Size code	L ±0.3	W ±0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5

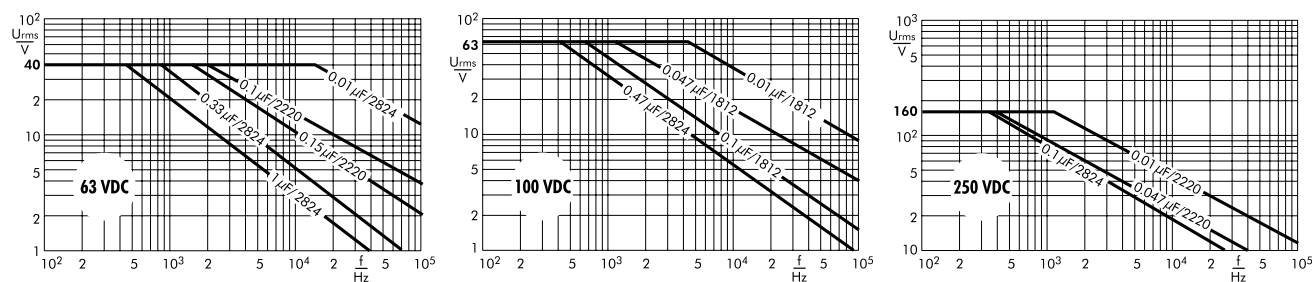
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Continuation

Impedance change with frequency
(general guide).



Permissible AC voltage in relation to frequency at 10° C internal temperature rise
(general guide).



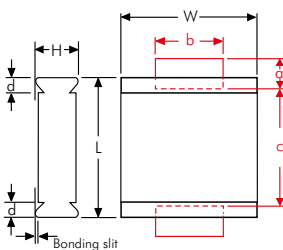
Recommendation for Processing and Application of SMD Capacitors



Layout Form

The components can generally be positioned on the carrier material as desired. In order to prevent soldering shadows or ensure regular temperature distribution, extreme concentration of the components should be avoided. In practice, it has proven best to keep a minimum distance of the soldering surfaces between two WIMA SMDs of twice the height of the components.

Solder Pad Recommendation



Size code	L ± 0.3	W ± 0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14

The solder pad size recommendations given for each individual series are to be understood as minimum dimensions which can at any time be adjusted to the layout form.

Processing

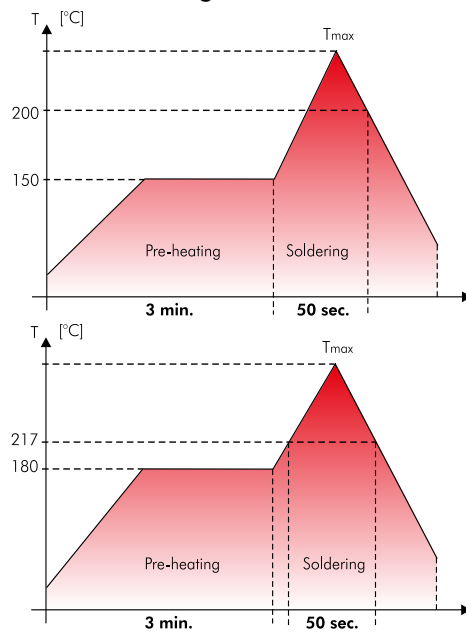
The processing of SMD components

- assembling
- soldering
- electrical final inspection/calibrating

must be regarded as a complete process. The soldering of the printed circuit board, for example, can constitute considerable stress on all the electronic components. The manufacturer's instructions on the processing of the components are mandatory.

Soldering Process

Re-flow soldering



SMD-PET	
Size code	Tmax.
1812	220° C
2220	230° C
2824	230° C
4030	230° C
5040	240° C
6054	250° C

SMD-PEN	
Size code	Tmax.
1812	220° C
2220	230° C
2824	230° C

SMD-PPS	
Size code	Tmax.
1812	250° C
2220	250° C
2824	250° C
4030	250° C
5040	250° C
6054	250° C

Temperature/time graph for the permissible processing temperature of the WIMA SMD film capacitor for typical convection soldering processes.

Due to versatile procedures exact processing parameters for re-flow soldering processes cannot be specified. The graph depicted is to be understood as a recommendation to help establishing a suitable soldering profile fulfilling the requirements

in practice at the user. During processing a max. temperature of $T=210^{\circ}\text{C}$ inside the component should not be exceeded. Due to the differing heat absorption the length of the soldering process should be kept as short as possible for smaller size codes.

SMD Handsoldering

WIMA SMD capacitors with plastic film dielectric are generally suitable for hand-soldering, e. g. for lab purposes, with a soldering iron where, however, similar to automated soldering processes, a certain duration and temperature should not be exceeded. These parameters are dependent on the physical size of the components and the relevant heat absorption involved.

The below data are to be regarded as guideline values and should serve to avoid damage to the dielectric caused by excessive heat during the soldering process. The soldering quality depends on the tool used and on the skill and experience of the person with the soldering iron in hand.

Size code	Temperature °C / °F	Time duration
1812	250 / 482	2 sec plate 1 / 5 sec off / 2 sec plate 2
2220	250 / 482	3 sec plate 1 / 5 sec off / 3 sec plate 2
2824	260 / 500	3 sec plate 1 / 5 sec off / 3 sec plate 2
4030	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2
5040	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2
6054	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2

Recommendation for Processing and Application of SMD Capacitors (Continuation)

Solder Paste

To achieve reliable soldering results one of the following solder alloys have from case to case proven being workable:

Lead free solder paste

Sn - Bi
Sn - Zn (Bi)
Sn - Ag - Cu (suitable for SMD-PET 5040/6054, SMD-PEN and SMD-PPS)

Solder paste with lead

Sn - Pb - Ag (Sn60-Pb40-A, Sn63-Pb37-A)

Washing

WIMA SMD components with plastic encapsulation - like all other components of similar construction irrespective of the make - cannot be regarded as hermetically sealed. Due to today's common washing substances, e. g. on aqueous basis instead of the formerly used halogenated hydrocarbons, with enhanced washing efficiency it became obvious that assembled SMD capacitors may show an impermissibly high deviation of the electrical parameters after a corresponding washing process. Hence it is recommended to refrain from applying industrial washing processes for WIMA SMD capacitors in order to avoid possible damages.

Initial Operation/Calibration

Due to the stress which the components are subjected to during processing, reversible parameter changes occur in almost all electronic components. The capacitance recovery accuracy to be expected with careful processing is within a scope of

$$|\Delta C/C| \leq 5 \%$$

For the initial operation of the device a minimum storage time of

$$t \geq 24 \text{ hours}$$

is to be taken into account. With calibrated devices or when the application is largely dependent on capacitance it is

advisable to prolong the storage time to

$$t \geq 10 \text{ days}$$

In this way ageing effects of the capacitor structure can be anticipated. Parameter changes due to processing are not to be expected after this period of time

Humidity Protection Bags

Taped WIMA SMD capacitors are shipped in humidity protection bags according to JEDEC standard (ESD/EMI-shield/water-vapour proof).

Under controlled conditions the components can be stored two years and more in the originally sealed bag. Opened packing units should immediately be used up for processing. If storage is necessary the opened packing units should be stored air-tight in the original plastic bag.

Reliability

Taking account of the manufacturer's guidelines and compatible processing, the WIMA SMD stand out for the same high quality and reliability as the analogous through-hole WIMA series. The technology of metallized film capacitors used e.g. in WIMA SMD-PET achieves the best values for all fields of application. The expected value is about:

$$\lambda_0 \leq 2 \text{ fit}$$

Furthermore the production of all WIMA components is subject to the regulations laid down by ISO 9001:2015 as well as the guidelines for component specifications set out by IEC quality assessment system (IECQ) for electronic components.

Electrical Characteristics and Fields of Application

Basically the WIMA SMD series have the same electrical characteristics as the analogous through-hole WIMA capacitors. Compared to ceramic or tantalum dielectrics WIMA SMD capacitors have a

number of other outstanding qualities:

- favourable pulse rise time
- low ESR
- low dielectric absorption
- available in high voltage series
- large capacitance spectrum
- stand up to high mechanical stress
- good long-term stability

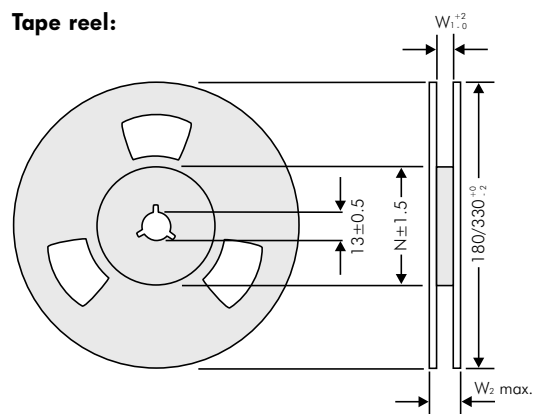
As regards technical performance as well as quality and reliability, the WIMA SMD series offer the possibility to cover nearly all applications of conventionally through-hole film capacitors with SMD components. Furthermore, the WIMA SMD series can now be used for all the demanding capacitor applications for which, in the past, the use of through-hole components was mandatory:

- measuring techniques
- oscillator circuits
- differentiating and integrating circuits
- A/D or D/A transformers
- sample and hold circuits
- automotive electronics

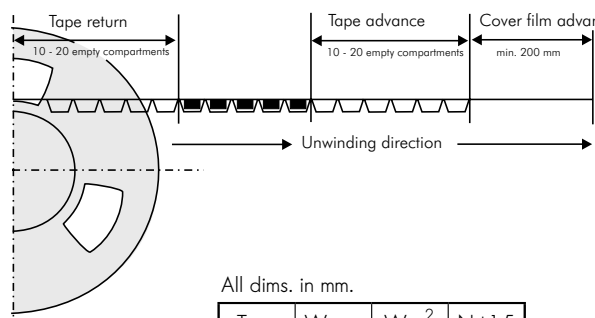
With the WIMA SMD programme available today, the major part of all plastic film capacitors can be replaced by WIMA SMD components. The field of application ranges from standard coupling capacitors to use in switch-mode power supplies as filter or charging capacitors with high voltage and capacitance values, as well as in telecommunications e.g. the well-known telephone capacitor $1 \mu\text{F}/250\text{VDC}$.

Blister Tape Packaging and Packing Units of the WIMA SMD Capacitors

Tape reel:

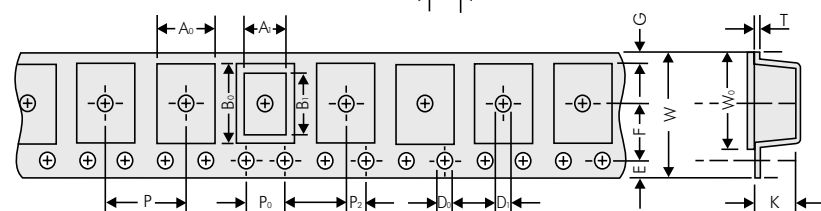


Tape advance and return:



All dims. in mm.

Type	W _{2max}	W ₁ ± 0.2	N ± 1.5
1812	19	12.4	62
2220	19	12.4	62
2824	19	12.4	62
4030	22.4	16.4	60
5040	30.4	24.4	90
6054	30.4	24.4	90



Packing units

Size Code 1812		A ₀ ± 0.1	A ₁	B ₀ ± 0.1	B ₁	D ₀ ± 0.1 - 0	D ₁ ± 0.1 - 0	P ± 0.1	P ₀ * ± 0.1	P ₂ ± 0.05	E ± 0.1	F ± 0.05	G	W ± 0.3	W ₀ ± 0.2	K ± 0.1	T ± 0.1
Box size	Code																
4.8x3.3x3	KA	3.55	3.3	5.1	4.8	Ø1.5	Ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	3.4	0.3
4.8x3.3x4	KB	3.55	3.3	5.1	4.8	Ø1.5	Ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	4.4	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk Standard
700	2500	3000
500	2000	3000

Size Code 2220		A ₀ ± 0.1	A ₁	B ₀ ± 0.1	B ₁	D ₀ ± 0.1 - 0	D ₁ ± 0.1 - 0	P ± 0.1	P ₀ * ± 0.1	P ₂ ± 0.05	E ± 0.1	F ± 0.05	G	W ± 0.3	W ₀ ± 0.2	K ± 0.1	T ± 0.1
Box size	Code																
5.7x5.1x3.5	QA	6.3	5.7	5.6	5.1	Ø1.5	Ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	3.7	0.3
5.7x5.1x4.5	QB	6.3	5.7	5.6	5.1	Ø1.5	Ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	4.7	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk Standard
500	1800	3000
400	1500	3000

Size Code 2824		A ₀ ± 0.1	A ₁	B ₀ ± 0.1	B ₁	D ₀ ± 0.1 - 0	D ₁ ± 0.1 - 0	P ± 0.1	P ₀ * ± 0.1	P ₂ ± 0.05	E ± 0.1	F ± 0.05	G	W ± 0.3	W ₀ ± 0.2	K ± 0.1	T ± 0.1
Box size	Code																
7.2x6.1x3	TA	6.6	6.1	7.7	7.2	Ø1.5	Ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	3.4	0.3
7.2x6.1x5	TB	6.6	6.1	7.7	7.2	Ø1.5	Ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	5.4	0.4

taped Reel 330 mm Ø	bulk Standard
1500	2000
750	2000

		Code	A ₀ ± 0.1	A ₁	B ₀ ± 0.1	B ₁	D ₀ ± 0.1 - 0	D ₁ ± 0.1 - 0	P ± 0.1	P ₀ * ± 0.1	P ₂ ± 0.05	E ± 0.1	F ± 0.05	G	W ± 0.3	W ₀ ± 0.2	K ± 0.1	T ± 0.1
Size Code 4030		VA	10.7	10.2	8.1	9.1	Ø1.5	Ø1.5	16	4	2	1.75	7.5	1.9	16	13.3	5.5	0.3
Size Code 5040		XA	13.5	12.7	11	11.5	Ø1.5	Ø1.5	16	4	2	1.75	11.5	4.7	24	21.3	6.5	0.3
Size Code 6054		YA	17.0	16.5	15.6	15.0	Ø1.5	Ø1.5	20	4	2	1.75	11.5	2.95	24	21.3	7.5	0.3

taped Reel 330 mm Ø	bulk Standard
775	2000
600	1000
450	500

* cumulative after 10 steps ± 0.2 mm max.
Samples and pre-production needs on request or 1 Reel minimum.

Part number codes for SMD packing

W (Blister)	Ø in mm	Code
12	180	P
12	330	Q
16	330	R
24	330	T
Bulk Standard		S

A WIMA part number consists of 18 digits and is composed as follows:

- Field 1 - 4: Type description
- Field 5 - 6: Rated voltage
- Field 7 - 10: Capacitance
- Field 11 - 12: Size and PCM
- Field 13 - 14: Version code (e.g. Snubber versions)
- Field 15: Capacitance tolerance
- Field 16: Packing
- Field 17 - 18: Pin length (untaped)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
M	K	S	2	C	0	2	1	0	0	1	A	0	0	M	S	S	D
MKS 2				63 VDC		0.01 µF				2.5x6.5x7.2		-		20%	bulk	6 -2	
Type description:				Rated voltage:		Capacitance:				Size:				Tolerance:			
SMD-PET = SMDT				50 VDC = B0		22 pF = 0022				4.8x3.3x3 Size 1812 = KA				±20% = M			
SMD-PEN = SMDN				63 VDC = C0		47 pF = 0047				4.8x3.3x4 Size 1812 = KB				±10% = K			
SMD-PPS = SMDI				100 VDC = D0		100 pF = 0100				5.7x5.1x3.5 Size 2220 = QA				±5% = J			
FKP 02 = FKPO				250 VDC = F0		150 pF = 0150				5.7x5.1x4.5 Size 2220 = QB				±2.5% = H			
MKS 02 = MKS0				400 VDC = G0		220 pF = 0220				7.2x6.1x3 Size 2824 = TA				±1% = E			
FKS 2 = FKS2				450 VDC = H0		330 pF = 0330				7.2x6.1x5 Size 2824 = TB				...			
FKP 2 = FKP2				520 VDC = H2		470 pF = 0470				10.2x7.6x5 Size 4030 = VA				Packing: AMMO H16.5 340x340 = A AMMO H16.5 490x370 = B AMMO H18.5 340x340 = C AMMO H18.5 490x370 = D REEL H16.5 360 = F REEL H16.5 500 = H REEL H18.5 360 = I REEL H18.5 500 = J ROLL H16.5 = N ROLL H18.5 = O BLISTER W12 180 = P BLISTER W12 330 = Q BLISTER W16 330 = R BLISTER W24 330 = T Bulk/TPS Standard = S ...			
FKS 3 = FKS3				600 VDC = I0		680 pF = 0680				12.7x10.2x6 Size 5040 = XA							
FKP 3 = FKP 3				630 VDC = J0		1000 pF = 1100				15.3x13.7x7 Size 6054 = YA							
MKS 2 = MKS2				700 VDC = K0		1500 pF = 1150				2.5x7x4.6 PCM 2.5 = 0B							
MKP 2 = MKP2				800 VDC = L0		2200 pF = 1220				3x7.5x4.6 PCM 2.5 = 0C							
MKS 4 = MKS4				850 VDC = M0		3300 pF = 1330				2.5x6.5x7.2 PCM 5 = 1A							
MKP 4 = MKP4				900 VDC = N0		4700 pF = 1470				3x7.5x7.2 PCM 5 = 1B							
MKP 10 = MKP1				1000 VDC = O1		6800 pF = 1680				2.5x7x10 PCM 7.5 = 2A							
FKP 4 = FKP4				1100 VDC = P0		0.01 µF = 2100				3x8.5x10 PCM 7.5 = 2B							
FKP 1 = FKP1				1200 VDC = Q0		0.022 µF = 2220				3x9x13 PCM 10 = 3A							
MKP-X2 = MKX2				1250 VDC = R0		0.047 µF = 2470				4x9x13 PCM 10 = 3C							
MKP-X1 R = MKX1				1500 VDC = S0		0.1 µF = 3100				5x11x18 PCM 15 = 4B							
MKP-Y2 = MKY2				1600 VDC = T0		0.22 µF = 3220				6x12.5x18 PCM 15 = 4C							
MP 3-X2 = MPX2				1700 VDC = TA		0.47 µF = 3470				5x14x26.5 PCM 22.5 = 5A							
MP 3-X1 = MPX1				2000 VDC = U0		1 µF = 4100				6x15x26.5 PCM 22.5 = 5B							
MP 3-Y2 = MPY2				2500 VDC = V0		2.2 µF = 4220				9x19x31.5 PCM 27.5 = 6A							
MP 3R-Y2 = MPRY				3000 VDC = W0		4.7 µF = 4470				11x21x31.5 PCM 27.5 = 6B							
MKP 4F = MKPF				4000 VDC = X0		10 µF = 5100				9x19x41.5 PCM 37.5 = 7A							
Snubber MKP = SNMP				6000 VDC = Y0		22 µF = 5220				11x22x41.5 PCM 37.5 = 7B							
Snubber FKP = SNFP				250 VAC = 0V		47 µF = 5470				19x31x56 PCM 48.5 = 8D							
GTO MKP = GTOM				275 VAC = 1V		100 µF = 6100				25x45x57 PCM 52.5 = 9D							
DC-LINK MKP 4 = DCP4				300 VAC = 2V		220 µF = 6220				...							
DC-LINK MKP 6 = DCP6				305 VAC = AV		1000 µF = 7100											
DC-LINK HC = DCHC				350 VAC = BV		1500 µF = 7150											
				440 VAC = 4V		...											
				500 VAC = 5V													
				...													

The data on this page is not complete and serves only to explain the part number system. Part number information is listed on the pages of the respective WIMA range.